## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Peter Gregorius	10/21/2005
Hermann Ruckerbauer	10/21/2005
Paul Wallner	10/21/2005

### **RECEIVING PARTY DATA**

Name:	Infineon Technologies AG
Street Address:	StMartin-Str. 53
City:	Munich
State/Country:	GERMANY
Postal Code:	81669

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11226457

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	3001.0017C
NAME OF SUBMITTER:	Patrick J. Finnan

Total Attachments: 4

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> PATENT REEL: 016717 FRAME: 0824

INFINEON REF NO. 13,577 O.C. REF NO. 3001,0017C

#### ASSIGNMENT

For Good And Valuable Consideration, WE, Peter GREGORIUS, a citizen of Germany, residing at Forstenrieder Allee 134, 81476 München, Germany; Hermann RUCKERBAUER, a citizen of Germany, residing at Veilchenstraße 1, 94554 Moos, Germany; and Paul WALLNER, a citizen of Germany, residing at Irmingardweg 7a, 83209 Prien, Germany, hereinafter individually or collectively referred to as "Assignor"

Hereby sell, assign and transfer to Infineon Technologies AG, a corporation, organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Str. 53, 81669 Munich, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and filed herewith, entitled:

# HIGH-SPEED INTERFACE CIRCUIT FOR SEMICONDUCTOR MEMORY CHIPS AND MEMORY SYSTEM INCLUDING THE SAME

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, it successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

P. 010

INFINEON REF NO. 13577 O.C, REF NO. 3001.0017C

SIGNATURE:	Peter GRAGORIUS	_ DATE:	21. Oct. 05
SIGNATURE:	Hermann RUCKERBAUER	_ DATE:	
SIGNATURE:	Pani YXY AT I NIED	_ DATE:	

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SIGNATURE:	Peter GREGORIUS	DATE:	
SIGNATURE:	Hermann RUCKERBAUER	DATE:	10/21/05
SIGNATURE:	Paul WALLNER	DATE:	·

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INFINEON REF NO. 13577 O.C. REF NO. 3001.0017C

SIGNATURE:	<u> </u>	DATE:	
	Peter GREGORIUS		,
SIGNATURE:	Hermann RUCKERBAUER	DATE:	
SIGNATURE:	Paul WALLINER	DATE:	2004-10-21

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PATENT REEL: 016717 FRAME: 0828